NSN 5962-01-231-8327

Memory Microcircuit - Page 1 of 1



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Body Length:

1.200 inches

Body Width:

0.295 inches

Body Height:

0.120 inches

Operating Tempurature Range:

-55.0 to 125.0 degrees celsius

Storage Tempurature Range:

-65.0 to 150.0 degrees celsius

Features Provided:

Electrostatic sensitive and high speed and high performance and high reliability

Inclosure Material:

Ceramic

Inclosure Configuration:

Dual-in-line

Output Logic Form:

Complementary-metal oxide-semiconductor logic

Input Circuit Pattern:

22 input

Terminal Surface Treatment:

Solder

Voltage Rating And Type Per Characteristic:

4.5 volts power source

Time Rating Per Chacteristic:

120.00 nanoseconds propagation delay time, low to high level output and 120.00 nanoseconds propagation delay time, high to low level output

Memory Device Type:

Rom

Test Data Document:

96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.).

Terminal Type And Quantity:

24 printed circuit

Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

Yes - demil/mli

Fiig:

A458a0